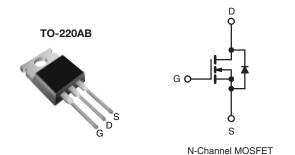


### Power MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	25	250			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.45			
Q <sub>g</sub> (Max.) (nC)	4	1			
Q <sub>gs</sub> (nC)	6	.5			
Q <sub>gd</sub> (nC)	2	22			
Configuration	Sin	Single			



#### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC





#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Load (Dh) froe	IRF634PbF
Lead (Pb)-free	SiHF634-E3
SnPb	IRF634
SIFD	SiHF634

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	250	V	
Gate-Source Voltage			V <sub>GS</sub>	± 20		
Continuous Drain Current		T <sub>C</sub> = 25 °C		8.1	A	
	V <sub>GS</sub> at 10 V	$T_C = 25 \degree C$ $T_C = 100 \degree C$	ID	5.1		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	32		
Linear Derating Factor				0.59	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	300	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	8.1	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	7.4	mJ	
Maximum Power Dissipation	T <sub>C</sub> =	25 °C	$P_{D}$	74	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.8	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>		
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N⋅m	

#### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = 50 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 7.3 \,^{\circ}\text{mH}$ ,  $R_g = 25 \,^{\circ}\Omega$ ,  $I_{AS} = 8.1 \,^{\circ}\text{A}$  (see fig. 12).
- c.  $I_{SD} \le 8.1$  A,  $dI/dt \le 120$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62	
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.7	

PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNIT	
Static						•	
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0$	250	-	-	٧	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		-	0.37	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$		2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Zoro Coto Voltago Duois Cumunt		V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V		-	-	25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 200 V, V	/ <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 5.1 A <sup>b</sup>	-	-	0.45	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 5	0 V, I <sub>D</sub> = 5.1 A <sup>b</sup>	1.6	-	-	S
Dynamic						•	
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$		-	770	-	pF
Output Capacitance	C <sub>oss</sub>			-	190	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	52	-	
Total Gate Charge	Qg		I <sub>D</sub> = 5.6 A, V <sub>DS</sub> = 200 V, see fig. 6 and 13 <sup>b</sup>	-	-	41	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		-	-	6.5	
Gate-Drain Charge	Q <sub>gd</sub>			-	-	22	
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = 125 V, $I_{D}$ = 5.6 A, $R_{g}$ = 12 $\Omega$ , $R_{D}$ = 22 $\Omega$ , see fig. 10 <sup>b</sup>		-	9.6	-	ns
Rise Time	t <sub>r</sub>			-	21	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	42	-	
Fall Time	t <sub>f</sub>			-	19	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	11111
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8.1	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	32	_ ^
Body Diode Voltage	V <sub>SD</sub>	$T_J = 25  ^{\circ}\text{C},  I_S = 8.1  \text{A},  V_{GS} = 0  \text{V}^{\text{b}}$		-	-	2.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 5.6 A, dI/dt = 100 A/μs <sup>b</sup>		-	220	440	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	1.2	2.4	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn	on is do	minated b	y L <sub>S</sub> and	L <sub>D</sub> )	

#### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

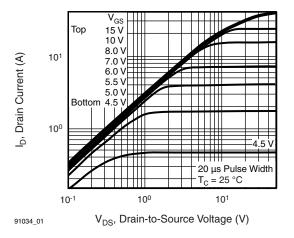


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

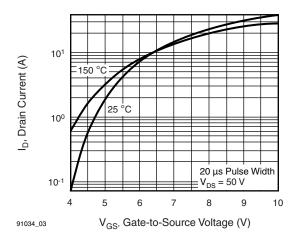


Fig. 3 - Typical Transfer Characteristics

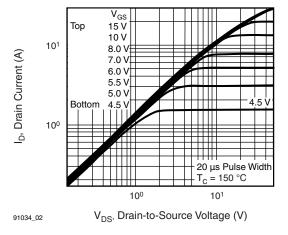


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

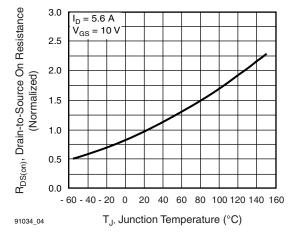
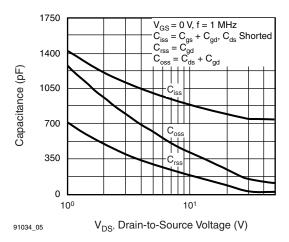


Fig. 4 - Normalized On-Resistance vs. Temperature





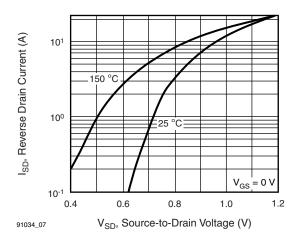
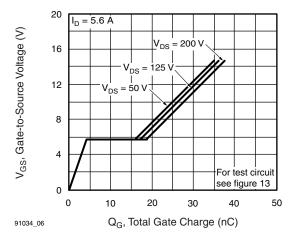


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

Fig. 7 - Typical Source-Drain Diode Forward Voltage



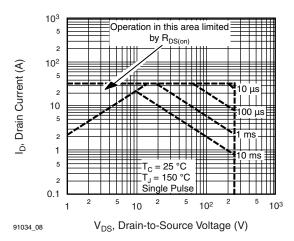


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

Fig. 8 - Maximum Safe Operating Area





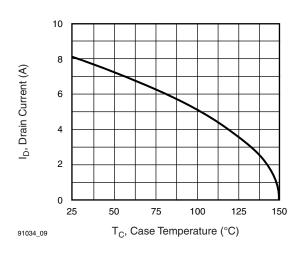


Fig. 9 - Maximum Drain Current vs. Case Temperature

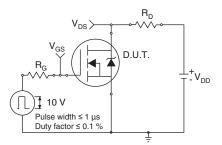


Fig. 10a - Switching Time Test Circuit

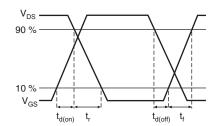


Fig. 10b - Switching Time Waveforms

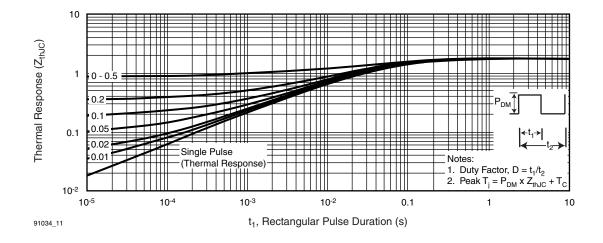


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



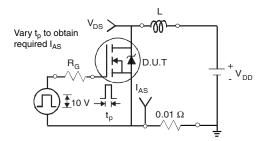


Fig. 12a - Unclamped Inductive Test Circuit

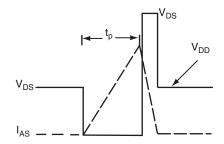


Fig. 12b - Unclamped Inductive Waveforms

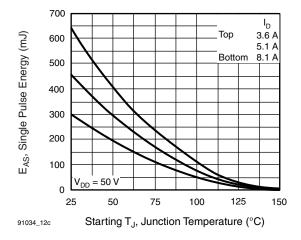


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

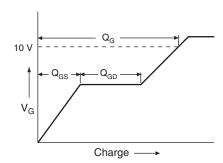


Fig. 13a - Basic Gate Charge Waveform

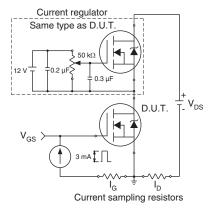
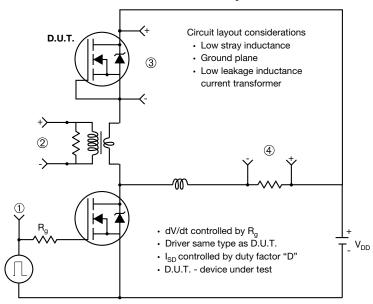


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



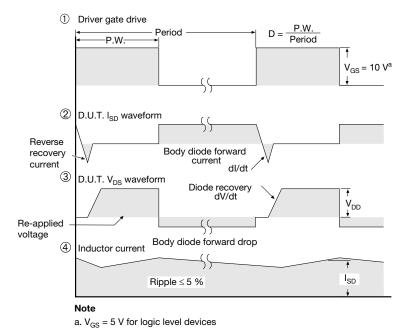


Fig. 14 - For N-Channel

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